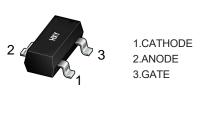


# FEATURES

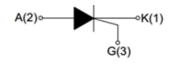
- RMS on-state current to 0.8A
- General purpose switching





## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MCR100-6	SOT-23	100-6	3000
MCR100-8	SOT-23	100-8	3000



#### ELECTRICAL CHARACTERISTICS (Ta=25 unless otherwise specified)

Symbol	Parameter	Part	Value	Unit
V <sub>DRM</sub>	Repetitive peak off-state voltage	MCR100-6	400	V
V <sub>RRM</sub>	Repetitive peak reverse voltage MCR100-8		600	V
V <sub>EBO</sub>	Emitter-Base Voltage		7	V
I <sub>T(RMS)</sub>	RMS on-state current(T=60℃)		0.8	А
I <sub>TSM</sub>	Non repetitive surge peak on-state current(tp=10ms)		8	А
I <sub>GM</sub>	Peak gate current (tp=20µs,Tj=110℃)		0.2	А
Р <sub>GM</sub>	Peak gate power (tp=20µs,Tj=110℃)		500	mW
PG(AV)	Average gate power dissipation(Tj=110 $^\circ \!\!\!\mathrm{C}$ )		100	mW
TJ	Operation Junction Temperature Range		-40~+110	°C
T <sub>stg</sub>	Storage Temperature Range		-40~+150	°C

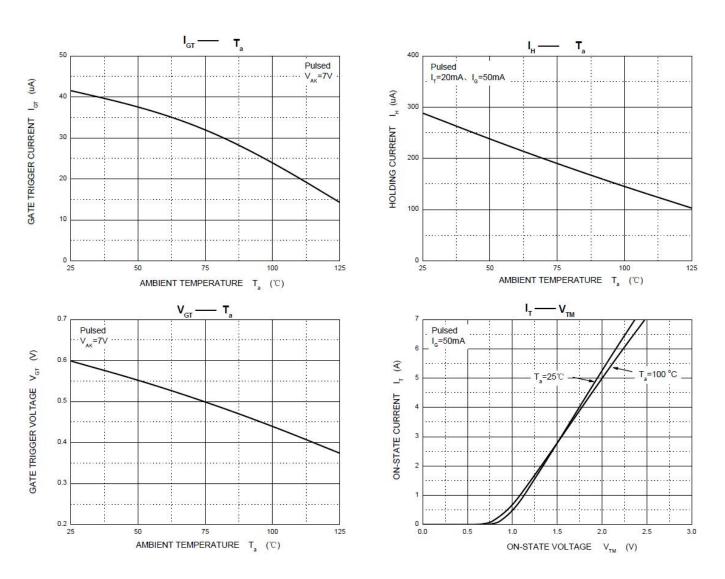


### Electrical Characteristics (Ta=25°C unless otherwise specified)

Symbol	Parameter	Test conditions	Part	Min	Тур	Мах	Unit	
V <sub>TM</sub>	On state voltage	I <sub>тм</sub> =1А ,tp=380µS				1.7	V	
V <sub>GT</sub>	Gate trigger voltage	V <sub>AK</sub> =7V				0.8V	V	
	Peak Repetitive forward and	L /L _400A	MCR100-6	400			V	
V <sub>(BR)EBO</sub>	Reverse blocking voltage	I <sub>DRM</sub> /I <sub>RRM</sub> =100μA	MCR100-8	600			V	
I <sub>DRM</sub>	Peak forward or reverse					10		
I <sub>RRM</sub>	blocking Current	$V_{AK} = V_{DRM} \text{ or } V_{RRM}$				10	10 µA	
Iн	Holding current	I <sub>HL</sub> =20mA ,V <sub>AK</sub> =7V				5	mA	
I <sub>GT</sub>	Gate trigger current	V <sub>AK</sub> =7V		15		60	μA	

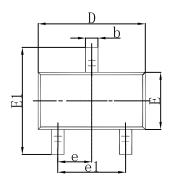
\* Forward current applied for 1 ms maximum duration duty cycle1%.

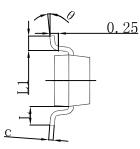
# **TypicalCharacteristics**

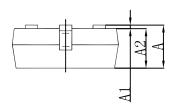




### **SOT-23 Package Outline Dimensions**







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
Е	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
e	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

## SOT-23 Suggested Pad Layout



Note:

1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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